CLAIMS

What is claimed is:

A circuit apparatus, comprising: 1.

a laminar support;

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a conductive track on the laminar support;

an auxiliary conductive element electrically connected to the conductive

track, wherein the auxiliary conductive element is applied by means of an

apparatus for applying SMD components.

The apparatus of claim 1, wherein the auxiliary conductive element is 2.

electrically connected to the laminar support by means of an adhesive and soldered

thereto by a wave soldering procedure.

The apparatus of claim 1, wherein the auxiliary conductive element is 3.

electrically connected to the laminar support by means of a cream solder and a

reflow soldering procedure.

The apparatus of claim 1, wherein said laminar support includes a first face a 4.

second face, and a thickness, the first face exhibits a plurality of auxiliary

conductive elements and a plurality of SMD electronic components, the second face

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exhibits a plurality of electronic components furnished with legs, and the legs pass

through the thickness of the laminar support.

5. The apparatus of claim 4, wherein the auxiliary conductive elements are

mutually identical.

6. The apparatus of claim 1, wherein the auxiliary conductive element includes

a metal pad.

7. The apparatus of claim 1, wherein

the auxiliary conductive element is electrically connected to the conductive

track by a solder alloy; and

the auxiliary conductive element includes a metal with high electrical

conductivity, and

the auxiliary conductive element is coated with a metallic layer with both

high wettability and a melting temperature higher than the melting temperature of

the solder alloy.

8. A flexible material strip, comprising:

a plurality of auxiliary conductive elements; and

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a plurality of adjacent recesses, wherein each of the recesses houses a

respective auxiliary conductive element.

9. The flexible material strip of claim 8, wherein the auxiliary conductive

element includes a metal pad.

10. The flexible material strip of claim 8, wherein each auxiliary conductive

element is produced from a metal with high electrical conductivity and coated with

a metallic layer with both a wettability and a melting temperature sufficient for a

soldering process.

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